

NCV890231

Buck Switching Regulator - Automotive

2.0 A, 2 MHz

The NCV890231 is a fixed-frequency, monolithic, Buck switching regulator intended for Automotive, battery-connected applications that must operate with up to a 36 V input supply. The regulator is suitable for systems with low noise and small form factor requirements often encountered in automotive driver information systems. The NCV890231 is capable of converting the typical 4.5 V to 18 V automotive input voltage range to outputs as low as 3.3 V at a constant switching frequency above the sensitive AM band, eliminating the need for costly filters and EMI countermeasures. Two pins are provided to synchronize switching to a clock, or to another NCV890231. The NCV890231 also provides several protection features expected in Automotive power supply systems such as current limit, short circuit protection, and thermal shutdown. In addition, the high switching frequency produces low output voltage ripple even when using small inductor values and an all-ceramic output filter capacitor – forming a space-efficient switching regulator solution.

Features

- Internal N-Channel Power Switch
- Low V_{IN} Operation Down to 4.5 V
- High V_{IN} Operation to 36 V
- Withstands Load Dump to 45 V
- 2 MHz Free-running Switching Frequency
- Auto-synchronizes with Other NCV890231 or to an External Clock
- Logic level Enable Input Can be Directly Tied to Battery
- 2.2 A (min) Cycle-by-Cycle Peak Current Limit
- Short Circuit Protection enhanced by Frequency Foldback
- $\pm 1.75\%$ Output Voltage Tolerance
- Output Voltage Adjustable Down to 0.8 V
- 1.4 Millisecond Internal Soft-Start

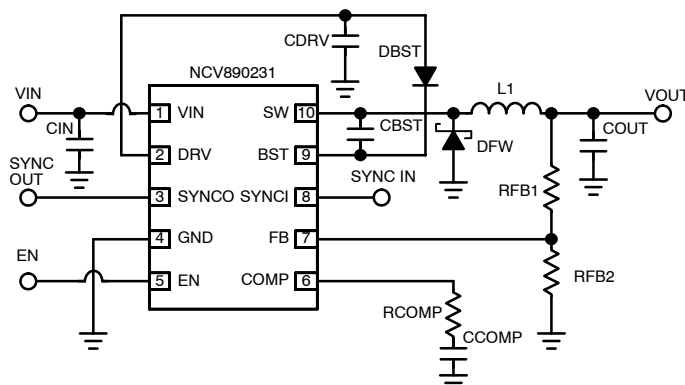


Figure 1. Typical Application



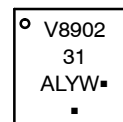
ON Semiconductor®

www.onsemi.com

MARKING DIAGRAM



DFN10
CASE 485C



A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Device

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 18 of this data sheet.

- Thermal Shutdown (TSD)
- Low Shutdown Current
- Wettable Flanks – DFN
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Audio
- Infotainment
- Safety – Vision Systems
- Instrumentation

NCV890231

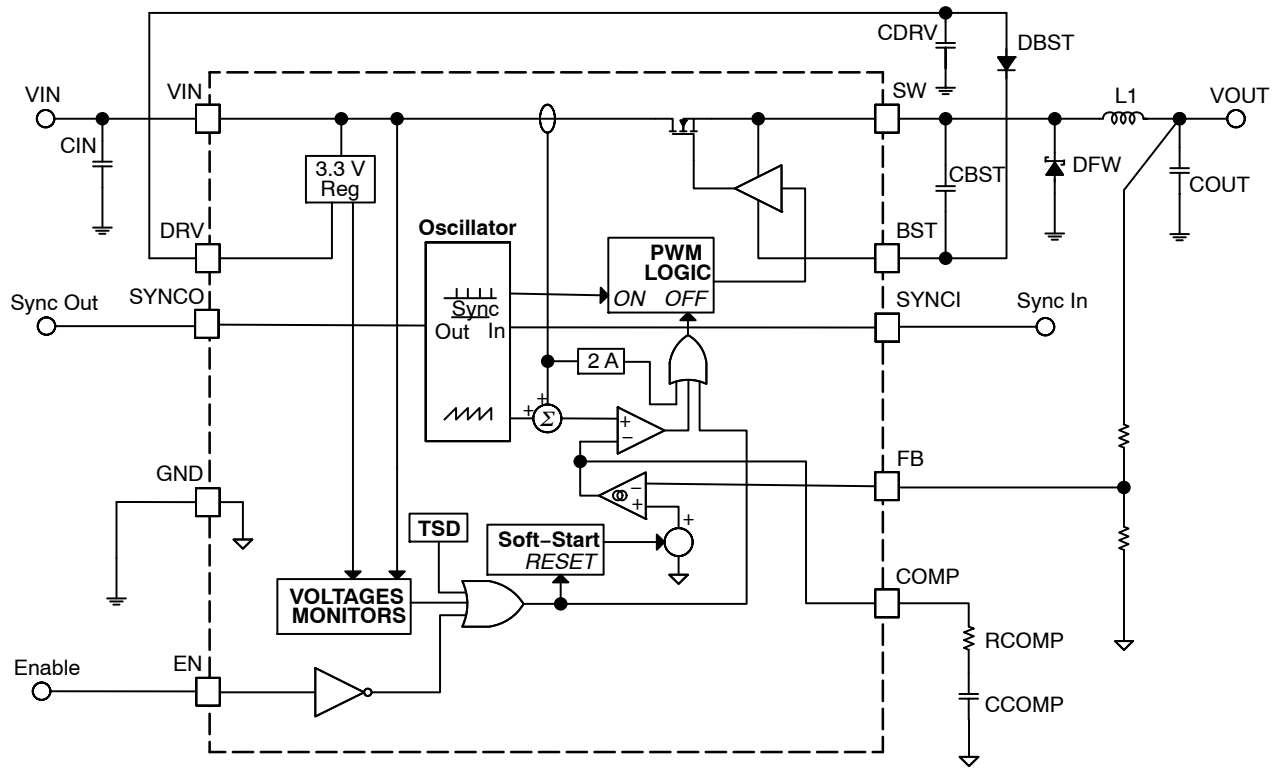


Figure 2. NCV890231 Block Diagram

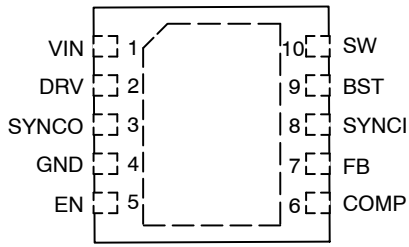
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Min/Max Voltage VIN		–0.3 to 45	V
Max Voltage VIN to SW		45	V
Min/Max Voltage SW		–0.7 to 40	V
Min Voltage SW – 20ns		–3.0	V
Min/Max Voltage BST		–0.3 to 40	
Min/Max Voltage BST to SW		–0.3 to 3.6	V
Min/Max Voltage on EN		–0.3 to 40	V
Min/Max Voltage COMP		–0.3 to 2	V
Min/Max Voltage FB		–0.3 to 18	V
Min/Max Voltage SYNCO		–0.3 to 3.6	V
Min/Max Voltage DRV		–0.3 to 3.6	V
Min/Max Voltage SYNCI		–0.3 to 6	V
Thermal Resistance, 3x3 DFN Junction–to–Ambient*	$R_{\theta JA}$	50	°C/W
Storage Temperature range		–55 to +150	°C
Operating Junction Temperature Range	T_J	–40 to +150	°C
ESD withstand Voltage	Human Body Model Machine Model Charge Device Model	2.0 200 >1.0	kV V kV
Moisture Sensitivity	MSL	Level 1	
Peak Reflow Soldering Temperature		260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

*Mounted on 1 sq. in. of a 4–layer PCB with 1 oz. copper thickness.

NCV890231



(Top View)

Figure 3. Pin Connections

PIN FUNCTION DESCRIPTIONS

Pin No.	Symbol	Description
1	VIN	Input voltage from battery. Place an input filter capacitor in close proximity to this pin.
2	DRV	Output voltage to provide a regulated voltage to the Power Switch gate driver.
3	SYNCO	Synchronization output. Turn-on of the Power Switch causes the SYNCO signal to fall. SYNCO rises half a switching period later. Connecting to the SYNCI pin of another NCV890231 causes them to switch out-of-phase
4	GND	Battery return, and output voltage ground reference.
5	EN	This TTL compatible Enable input allows the direct connection of Battery as the enable signal. Grounding this input stops switching and reduces quiescent current draw to a minimum.
6	COMP	Error Amplifier output, for tailoring transient response with external compensation components.
7	FB	Feedback input pin to program output voltage, and detect pre-charged or shorted output conditions.
8	SYNCI	Synchronization input. Connecting an external clock to the SYNCI pin synchronizes switching to the rising edge of the SYNCI voltage.
9	BST	Bootstrap input provides drive voltage higher than VIN to the N-channel Power Switch for optimum switch $R_{DS(on)}$ and highest efficiency.
10	SW	Switching node of the Regulator. Connect the output inductor and cathode of the freewheeling diode to this pin.
Exposed Pad		Connect to Pin 4 (electrical ground) and to a low thermal resistance path to the ambient temperature environment.

ELECTRICAL CHARACTERISTICS ($V_{IN} = 4.5\text{ V to }28\text{ V}$, $V_{EN} = 5\text{ V}$, $V_{BST} = V_{SW} + 3.0\text{ V}$, $C_{DRV} = 0.1\text{ }\mu\text{F}$, Min/Max values are valid for the temperature range $-40^{\circ}\text{C} \leq T_J \leq 150^{\circ}\text{C}$ unless noted otherwise, and are guaranteed by test, design or statistical correlation.)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
-----------	--------	------------	-----	-----	-----	------

QUIESCENT CURRENT

Quiescent Current, shutdown	I_{qSD}	$V_{IN} = 13.2\text{ V}$, $V_{EN} = 0\text{ V}$, $T_J = 25^{\circ}\text{C}$			10	μA
Quiescent Current, enabled	I_{qEN}	$V_{IN} = 13.2\text{ V}$			3.0	mA

UNDERVOLTAGE LOCKOUT – VIN (UVLO)

UVLO Start Threshold	V_{UVLSTT}	V_{IN} rising	4.1		4.5	V
UVLO Stop Threshold	V_{UVLSTP}	V_{IN} falling	3.9		4.4	V
UVLO Hysteresis	V_{UVLOHY}		0.1		0.2	V

ENABLE (EN)

Logic Low	V_{ENLO}		0.8			V
Logic High	V_{ENHI}				2.0	V
Input Current	I_{EN}		8.0		30	μA

SOFT-START (SS)

Soft-Start Completion Time	t_{SS}		0.8	1.4	2.0	ms
----------------------------	----------	--	-----	-----	-----	----

VOLTAGE REFERENCE

FB Pin Voltage during regulation	V_{FBR}	COMP shorted to FB	0.786	0.8	0.814	V
----------------------------------	-----------	--------------------	-------	-----	-------	---

ERROR AMPLIFIER

FB Bias Current	I_{FBBIAS}	$V_{FB} = 0.8\text{ V}$	0.25		1.0	μA
Transconductance	g_m $g_m(HV)$	$V_{COMP} = 1.3\text{ V}$ $4.5\text{ V} < V_{IN} < 18\text{ V}$ $20\text{ V} < V_{IN} < 28\text{ V}$	0.6 0.3	1.0 0.5	1.5 0.75	mmho
Output Resistance	R_{OUT}			1.4		$\text{M}\Omega$
COMP Source Current Limit	I_{SOURCE}	$V_{FB} = 0.63\text{ V}$, $V_{COMP} = 1.3\text{ V}$ $4.5\text{ V} < V_{IN} < 18\text{ V}$ $20\text{ V} < V_{IN} < 28\text{ V}$		75 40		μA
COMP Sink Current Limit	I_{SINK}	$V_{FB} = 0.97\text{ V}$, $V_{COMP} = 1.3\text{ V}$ $4.5\text{ V} < V_{IN} < 18\text{ V}$ $20\text{ V} < V_{IN} < 28\text{ V}$		75 40		μA
Minimum COMP voltage	V_{CMPMIN}	$V_{FB} = 0.97\text{ V}$	0.2		0.7	V

OSCILLATOR

Frequency	F_{SW} $F_{SW}(HV)$	$4.5 < V_{IN} < 18\text{ V}$ $20\text{ V} < V_{IN} < 28\text{ V}$	1.8 0.9	2.0 1.0	2.2 1.1	MHz
-----------	--------------------------	--	------------	------------	------------	-----

VIN FREQUENCY FOLDBACK MONITOR

Frequency Foldback Threshold V_{IN} rising V_{IN} falling	V_{FLDUP} V_{FLDDN}	$V_{FB} = 0.63\text{ V}$	18.4 18		20 19.8	V
Frequency Foldback Hysteresis	V_{FLDHY}		0.2	0.3	0.4	V

SYNCHRONIZATION

SYNCO Output Pulse Duty Ratio	$D_{(SYNC)}$	$C_{LOAD} = 40\text{ pF}$	40		60	%
SYNCO Output Pulse Falltime	$t_{R(SYNC)}$	$C_{LOAD} = 40\text{ pF}$, 90% to 10%		4		ns
SYNCO Output Pulse Risettime	$t_{F(SYNC)}$	$C_{LOAD} = 40\text{ pF}$, 10% to 90%		4		ns
SYNCI Input Resistance to ground	$R_{H(SYNC)}$	$V_{SYNCl} = 5.0\text{ V}$	50		200	$\text{k}\Omega$
SYNCI Input High Threshold Voltage	V_{HSYNCl}				2.0	V
SYNCI Input Low Threshold Voltage	V_{LSYNCl}		0.8			V
SYNCI High Pulse Width	t_{HSYNCl}	$V_{SYNCl} > \max V_{HSYNCl}$	40			ns

1. Not tested in production. Limits are guaranteed by design.

ELECTRICAL CHARACTERISTICS ($V_{IN} = 4.5\text{ V to }28\text{ V}$, $V_{EN} = 5\text{ V}$, $V_{BST} = V_{SW} + 3.0\text{ V}$, $C_{DRV} = 0.1\text{ }\mu\text{F}$, Min/Max values are valid for the temperature range $-40^{\circ}\text{C} \leq T_J \leq 150^{\circ}\text{C}$ unless noted otherwise, and are guaranteed by test, design or statistical correlation.)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
-----------	--------	------------	-----	-----	-----	------

SYNCHRONIZATION

SYNCl Low Pulse Width	t_{LSYNCl}	$V_{SYNC} < \min V_{LSYNC}$	40			ns
External Sync Frequency	F_{SYNCl}		1.8		2.5	MHz
Master Reassertion Time	$t_{l(SYNCl)}$	Time from last rising SYNCl edge to first un-synchronized turn-on.		650		ns

VIN OVERVOLTAGE SHUTDOWN MONITOR

Overvoltage Stop Threshold	V_{OVSTP}		32.4		36	V
Overvoltage Start Threshold	V_{OVSTT}		30		35.4	V
Overvoltage Hysteresis	V_{OVHY}		0.6	1.5	2.4	V

SLOPE COMPENSATION

Ramp Slope (Note 1) (With respect to switch current)	S_{ramp} $S_{ramp(HV)}$	$4.5 < V_{IN} < 18\text{ V}$ $20\text{ V} < V_{IN} < 28\text{ V}$	0.7 0.25		1.3 0.6	A/ μs
---	------------------------------	--	-------------	--	------------	------------------

POWER SWITCH

ON Resistance	R_{DSON}	$V_{BST} = V_{SW} + 3.0\text{ V}$			650	$\text{m}\Omega$
Leakage current VIN to SW	I_{LKSW}	$V_{EN} = 0\text{ V}$, $V_{SW} = 0$, $V_{IN} = 18\text{ V}$			10	μA
Minimum ON Time	t_{ONMIN}	Measured at SW pin	45		70	ns
Minimum OFF Time	t_{OFFMIN}	Measured at SW pin At $F_{SW} = 2\text{ MHz}$ (normal) At $F_{SW} = 500\text{ kHz}$ (max duty cycle)	30	30 50	70	ns

PEAK CURRENT LIMIT

Current Limit Threshold	I_{LIM}		2.2	2.45	2.7	A
-------------------------	-----------	--	-----	------	-----	---

SHORT CIRCUIT FREQUENCY FOLDBACK

Lowest Foldback Frequency Lowest Foldback Frequency – High V_{in} Hiccup Mode	F_{SWAF} F_{SWAFHV} F_{SWHIC}	$V_{FB} = 0\text{ V}$, $4.5\text{ V} < V_{IN} < 18\text{ V}$ $V_{FB} = 0\text{ V}$, $20\text{ V} < V_{IN} < 28\text{ V}$ $V_{FB} = 0\text{ V}$	400 200 24	500 250 32	600 300 40	kHz
---	---	--	------------------	------------------	------------------	-----

GATE VOLTAGE SUPPLY (DRV pin)

Output Voltage	V_{DRV}		3.1	3.3	3.5	V
DRV POR Start Threshold	V_{DRVSTT}		2.7	2.9	3.05	V
DRV POR Stop Threshold	V_{DRVSTP}		2.5	2.8	3.0	V
DRV Current Limit	I_{DRVLIM}	$V_{DRV} = 0\text{ V}$	16		45	mA

OUTPUT PRECHARGE DETECTOR

Threshold Voltage	V_{SSEN}		20	35	50	mV
-------------------	------------	--	----	----	----	----

THERMAL SHUTDOWN

Activation Temperature (Note 1)	T_{SD}		150		190	$^{\circ}\text{C}$
Hysteresis (Note 1)	T_{HYS}		5		20	$^{\circ}\text{C}$

1. Not tested in production. Limits are guaranteed by design.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS CURVES



Figure 4. Shutdown Quiescent Current vs. Junction Temperature



Figure 5. Enabled Quiescent Current vs. Junction Temperature

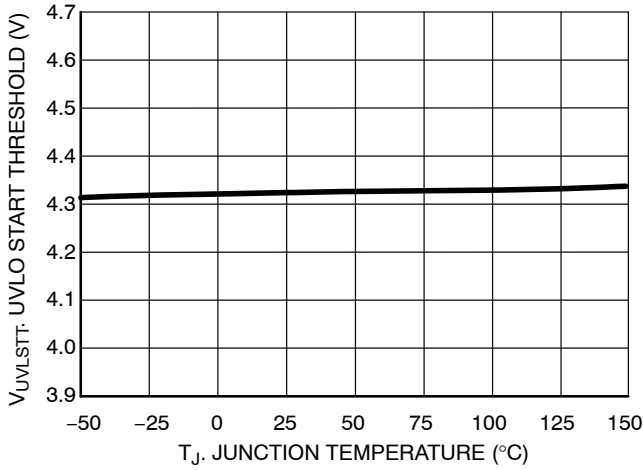


Figure 6. UVLO Start Threshold vs. Junction Temperature

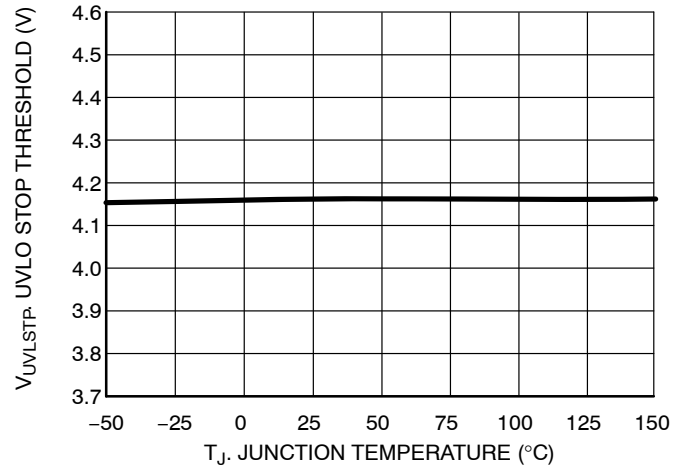


Figure 7. UVLO Stop Threshold vs. Junction Temperature



Figure 8. Soft-Start Duration vs. Junction Temperature



Figure 9. FB Regulation Voltage vs. Junction Temperature

TYPICAL CHARACTERISTICS CURVES

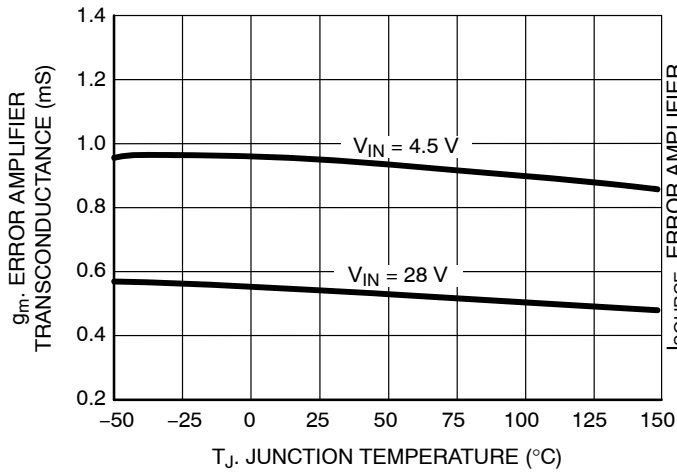


Figure 10. Error Amplifier Transconductance vs. Junction Temperature

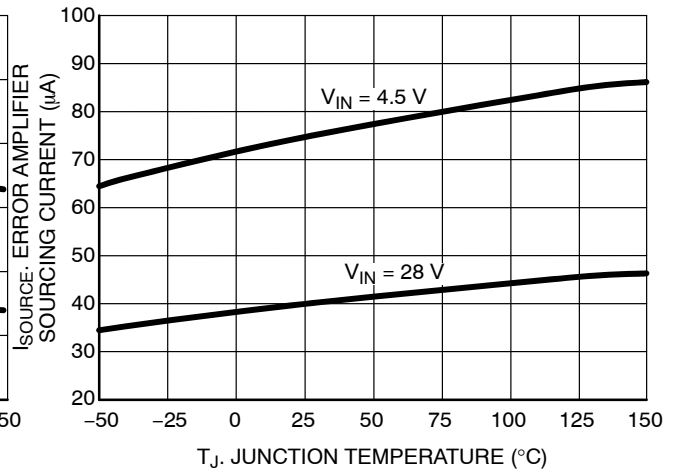


Figure 11. Error Amplifier Max Sourcing Current vs. Junction Temperature

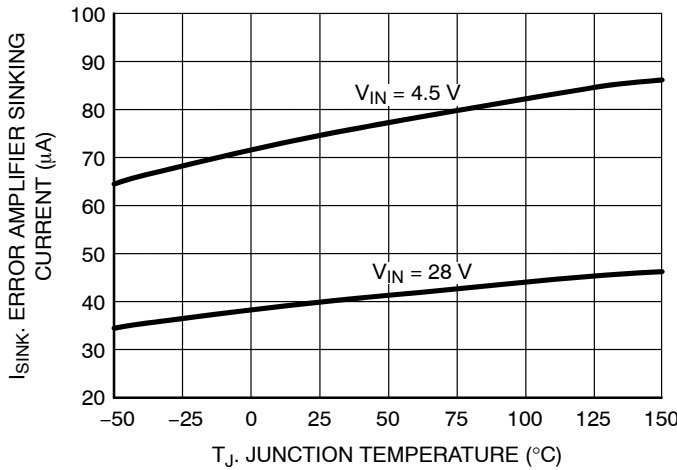


Figure 12. Error Amplifier Max Sinking Current vs. Junction Temperature

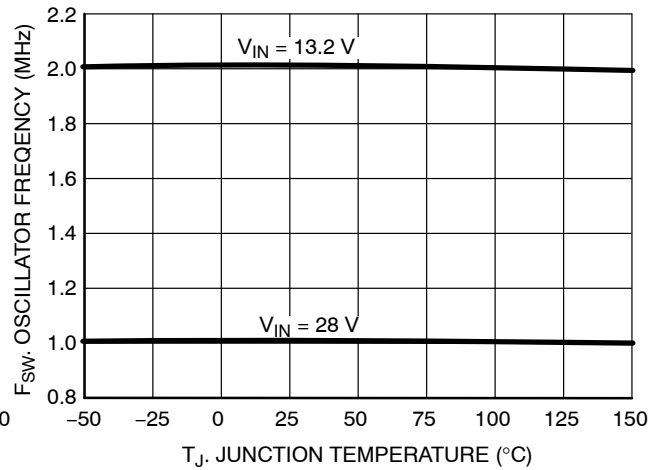


Figure 13. Oscillator Frequency vs. Junction Temperature

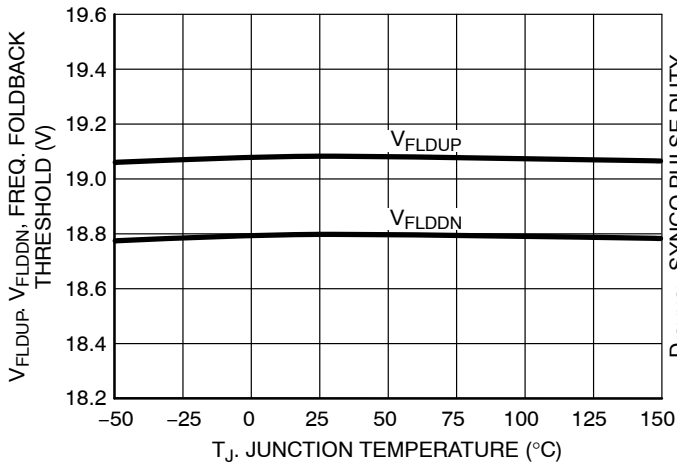


Figure 14. Rising Frequency Foldback Threshold vs. Junction Temperature

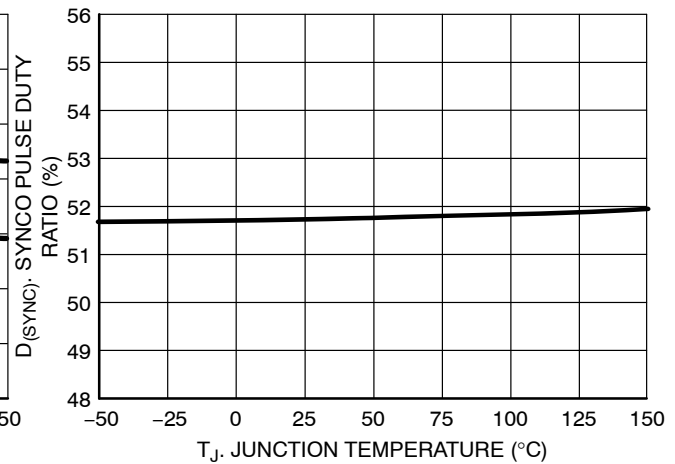


Figure 15. SYNCO Pulse Duty Ratio vs. Junction Temperature

TYPICAL CHARACTERISTICS CURVES

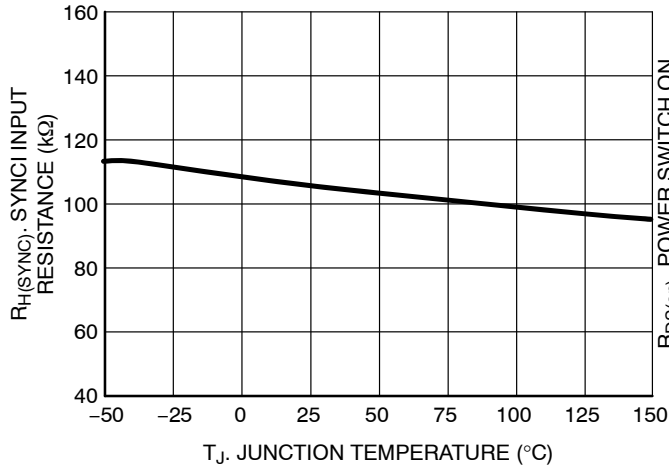


Figure 16. SYNCI Input Resistance vs. Junction Temperature

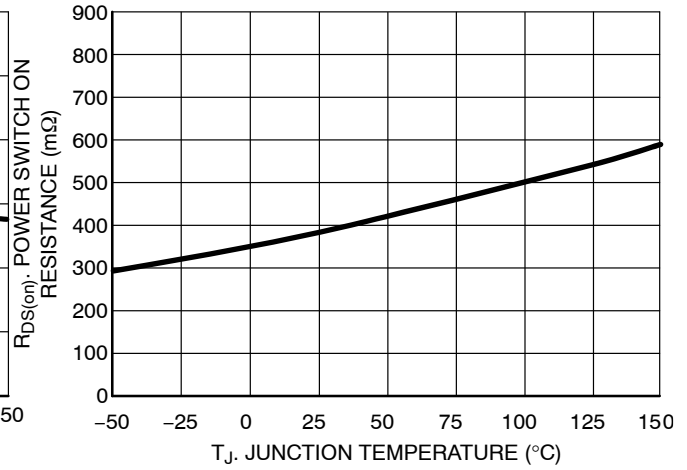


Figure 17. Power Switch R_{DS(on)} vs. Junction Temperature

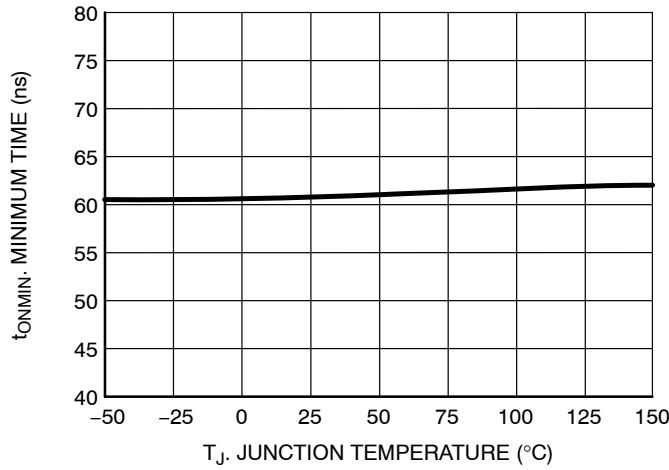


Figure 18. Minimum On Time vs. Junction Temperature

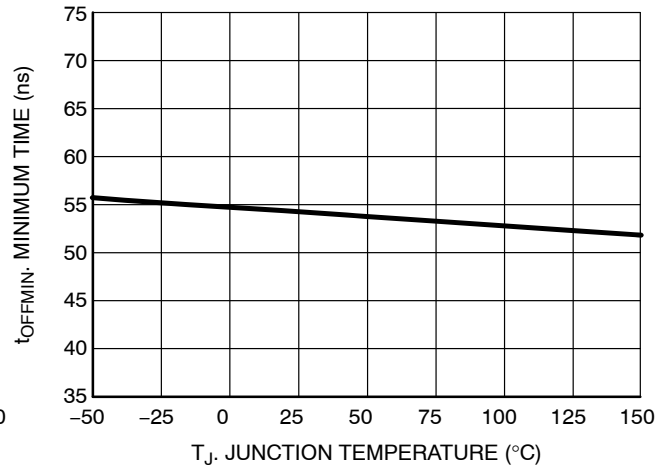


Figure 19. Minimum Off Time vs. Junction Temperature

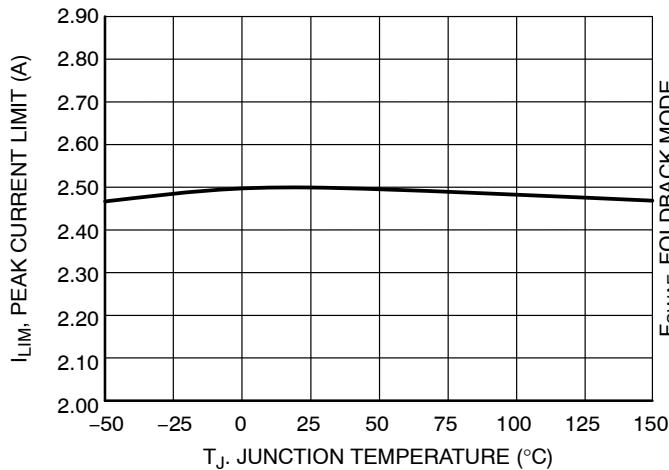


Figure 20. Current Limit Threshold vs. Junction Temperature

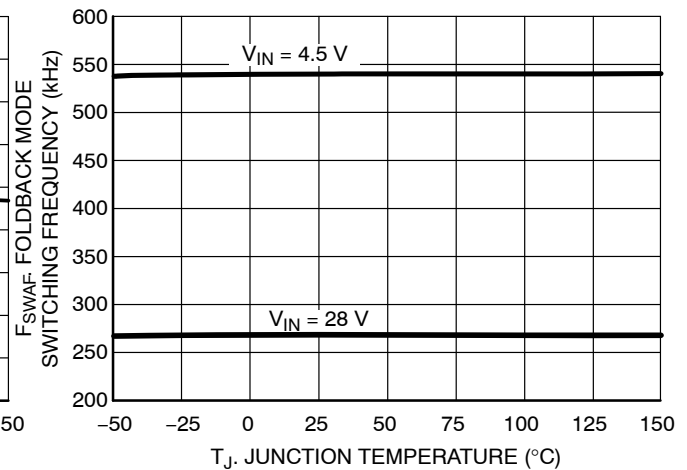


Figure 21. Short-Circuit Foldback Frequency vs. Junction Temperature

TYPICAL CHARACTERISTICS CURVES

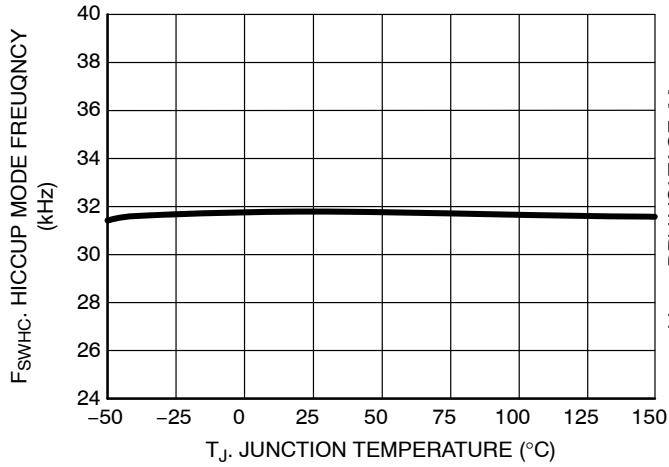


Figure 22. Hiccup Mode Switching Frequency vs. Junction Temperature

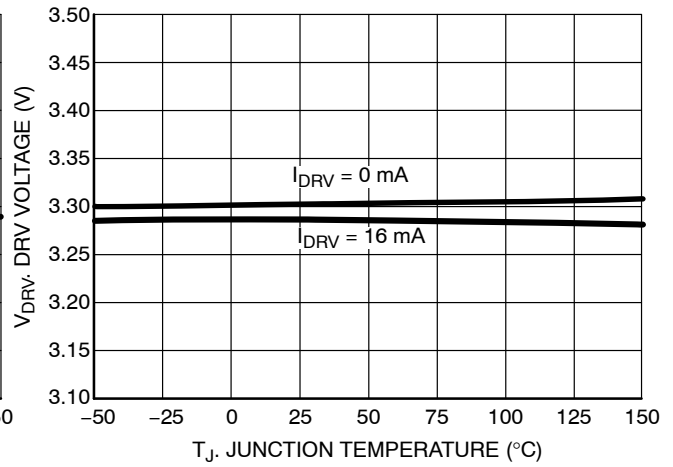


Figure 23. DRV Voltage vs. Junction Temperature

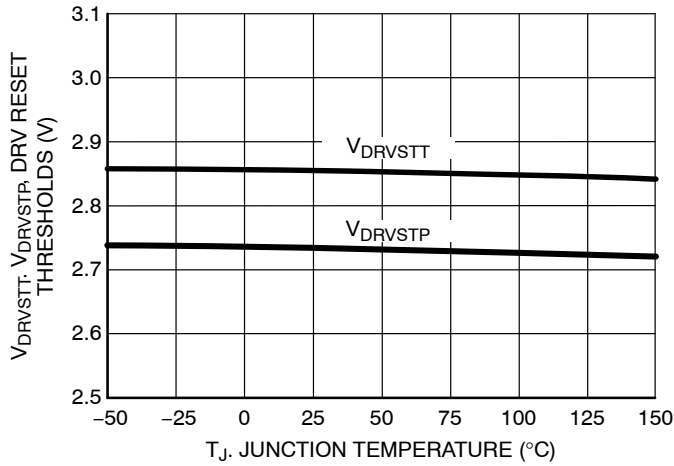


Figure 24. DRV Reset Threshold vs. Junction Temperature

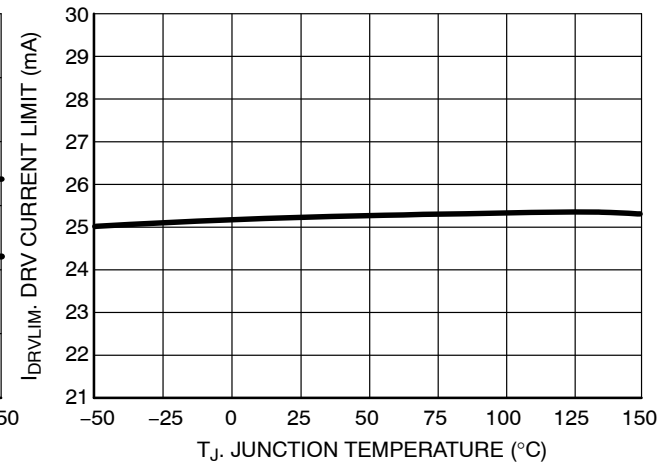


Figure 25. DRV Current Limit vs. Junction Temperature

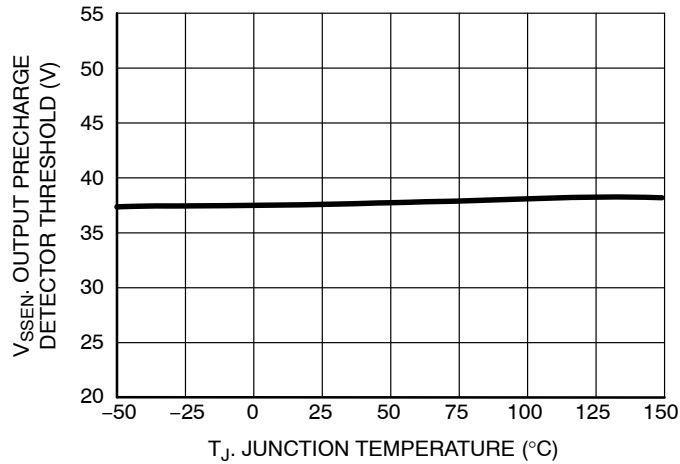


Figure 26. Output Precharge Detector Threshold vs. Junction Temperature

GENERAL INFORMATION

INPUT VOLTAGE

An Undervoltage Lockout (UVLO) circuit monitors the input, and inhibits switching and resets the Soft-start circuit if there is insufficient voltage for proper regulation. The NCV890231 can regulate a 3.3 V output with input voltages above 4.5 V and a 5.0 V output with an input above 6.5 V.

The NCV890231 automatically terminates switching if input voltage exceeds V_{OVSTP} (see Figure 27), and withstands input voltages up to 45 V.

To limit the power lost in generating the drive voltage for the Power Switch, the switching frequency is reduced by a factor of 2 when the input voltage exceeds the V_{IN} Frequency Foldback threshold V_{FLDUP} (see Figure 27). Frequency reduction is automatically terminated when the input voltage drops back below the V_{IN} Frequency Foldback threshold V_{FLDDN} .

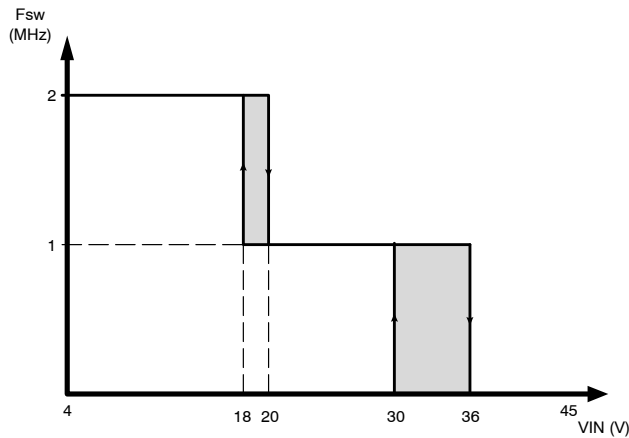


Figure 27. NCV890231 Switching Frequency Reduction at High Input Voltage

ENABLE

The NCV890231 is designed to accept either a logic level signal or battery voltage as an Enable signal. EN low induces a 'sleep mode' which shuts off the regulator and minimizes its supply current to a couple of μA typically (I_{QSD}) by disabling all functions. Upon enabling, voltage is established at the DRV pin, followed by a soft-start of the switching regulator output.

SOFT-START

Upon being enabled or released from a fault condition, and after the DRV voltage is established, a soft-start circuit ramps the switching regulator error amplifier reference voltage to the final value. During soft-start, the average switching frequency is lower than its normal mode value (typically 2 MHz) until the output voltage approaches regulation.

SLOPE COMPENSATION

A fixed slope compensation signal is generated internally and added to the sensed current to avoid increased output voltage ripple due to bifurcation of inductor ripple current at duty cycles above 50%. The fixed amplitude of the slope compensation signal requires the inductor to be greater than a minimum value, depending on output voltage, in order to avoid sub-harmonic oscillations. For 3.3 V and 5 V output voltages, the recommended inductor value is 4.7 μH .

SHORT CIRCUIT FREQUENCY FOLDBACK

During severe output overloads or short circuits, the NCV890231 automatically reduces its switching frequency. This creates duty cycles small enough to limit the peak current in the power components, while maintaining the ability to automatically reestablish the output voltage if the overload is removed. If the current is still too high after the switching frequency folds back to 500 kHz, the regulator enters an auto-recovery burst mode that further reduces the dissipated power.

CURRENT LIMITING

Due to the ripple on the inductor current, the average output current of a buck converter is lower than the peak current setpoint of the regulator. Figure 28 shows – for a 4.7 μH inductor – how the variation of inductor peak current with input voltage affects the maximum DC current the NCV890231 can deliver to a load.

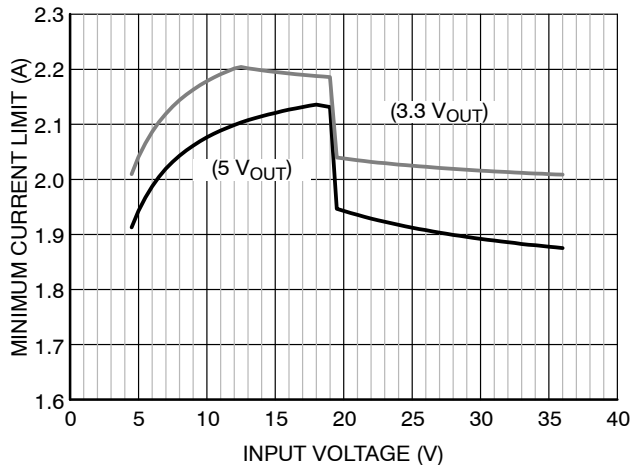


Figure 28. NCV890231 Load Current Capability with 4.7 μH Inductor

NCV890231

SYNCHRONIZATION

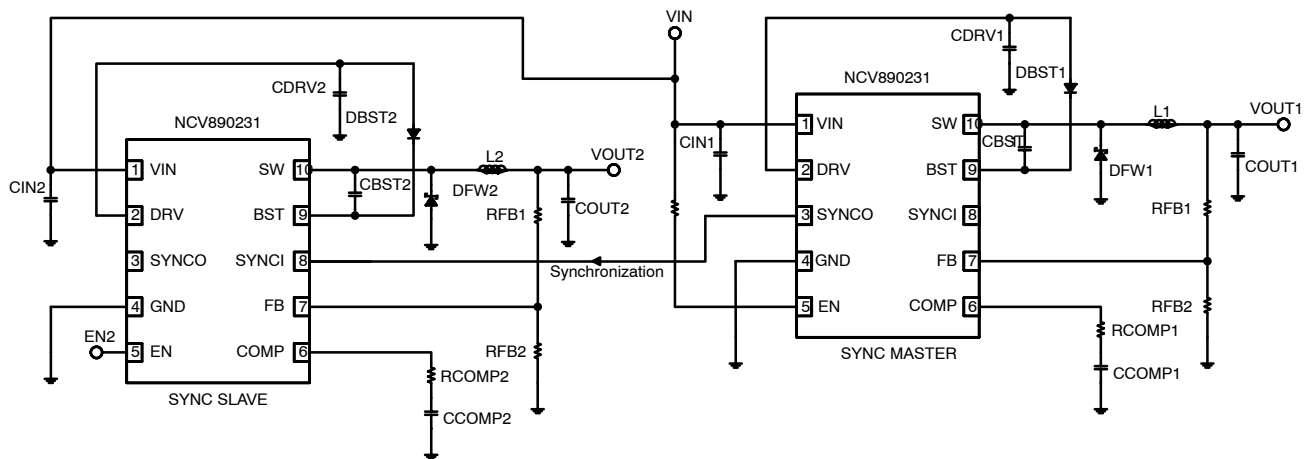
Two NCV890231 can be synchronized out-of-phase to one another by connecting the SYNCO pin of one to the SYNCI pin of the other (Figure 29). Any number of NCV890231 can also be synchronized to an external clock (Figure 30). If a part does not have its switching frequency controlled by the SYNCI input, it drives the SYNCO pin low when it turns on the power switch, and drives it high half a switching period later. When the switching frequency is controlled by the SYNCI input, the SYNCO pin is held low. Synchronization starts within 2 ms of soft-start completion.

A rising edge at the SYNCI pin causes an NCV890231 to immediately turn on the power switch. If another rising edge

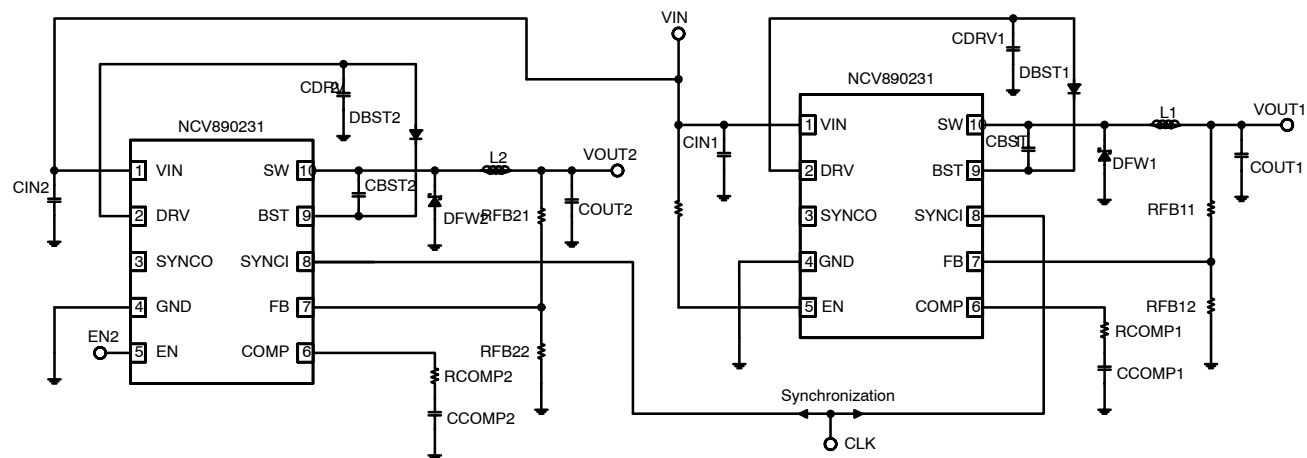
does not arrive at the SYNCI pin within the Master Reassertion Time, the NCV890231 controls its own switching frequency, allowing uninterrupted operation in the event that the clock (or controlling NCV890231) is turned off.

If internal conditions or excessive input voltage cause an NCV890231 to fold back its switching frequency, the main oscillator switching frequency is no longer derived from the frequency received at the SYNCI pin. Under these conditions, the SYNCO pin is held low.

An external pulldown resistor is not required at the SYNCI pin if it is unconnected.



**Figure 29. NCV890231s Synchronized to Each Other
Master Enabled by Battery**



**Figure 30. Both NCV890231s Synchronized to External Clock
#1 Enabled by Battery**

BOOTSTRAP

At the DRV pin an internal regulator provides a ground-referenced voltage to an external capacitor (C_{DRV}), to allow fast recharge of the external bootstrap capacitor (C_{BST}) used to supply power to the power switch gate driver. If the voltage at the DRV pin goes below the DRV UVLO Threshold V_{DRVSTB} switching is inhibited and the Soft-start circuit is reset, until the DRV pin voltage goes back up above V_{DRVSTT} .

In order for the bootstrap capacitor to stay charged, the Switch node needs to be pulled down to ground regularly. In very light load condition, the NCV890231 skips switching cycles to ensure the output voltage stays regulated. When the skip cycle repetition frequency gets too low, the bootstrap voltage collapses and the regulator stops switching. Practically, this means that the NCV890231 needs a minimum load to operate correctly. Figure 31 shows the minimum current requirements for different input and output voltages.

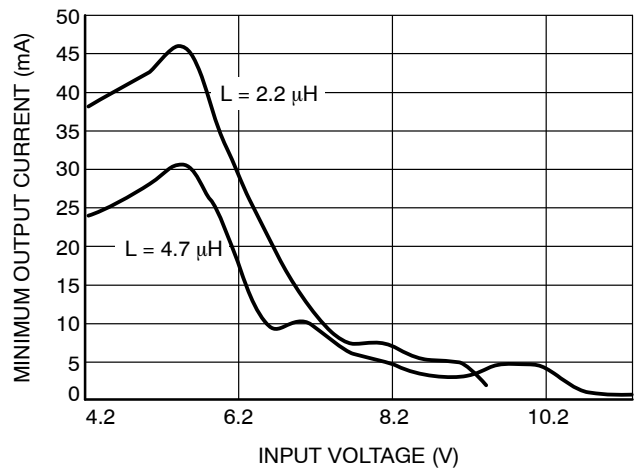
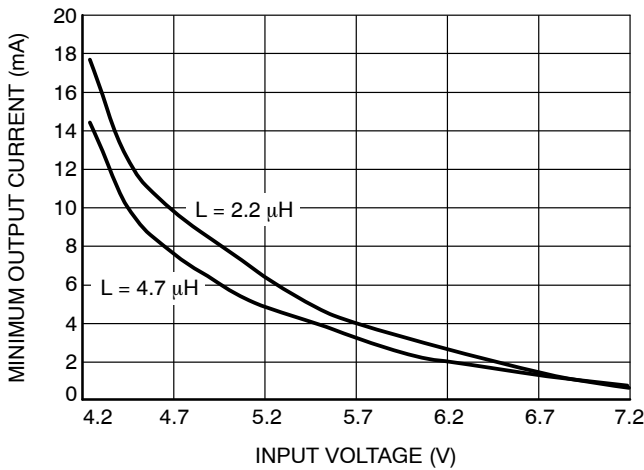
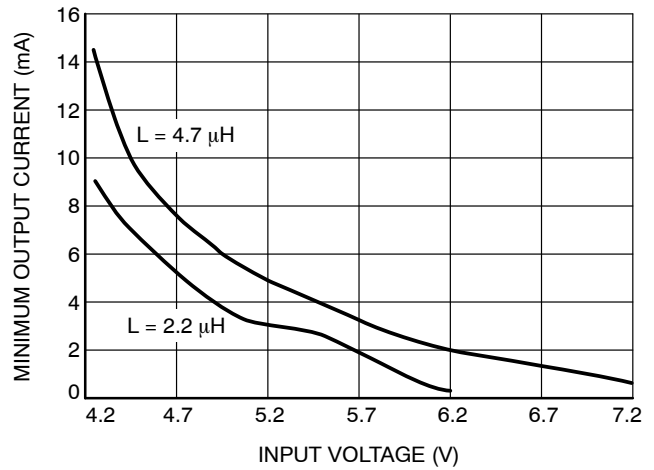
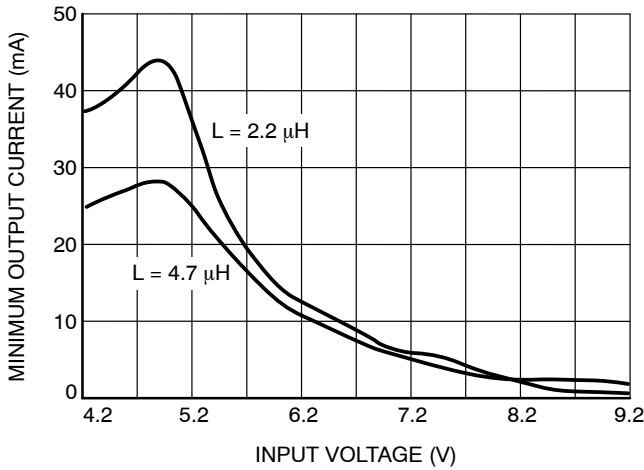


Figure 31. Minimum Load Current with Different Input and Output Voltages

OUTPUT PRECHARGE DETECTION

Prior to Soft-start, the FB pin is monitored to ensure the SW voltage is low enough to have charged the external bootstrap capacitor (C_{BST}). If the FB pin is higher than V_{SSEN} , restart is delayed until the output has discharged. Figure 32 shows the IC starts to switch after the voltage on FB pin reaches V_{SSEN} , even the EN pin is high. After the IC is switching, the FB pin follows the soft starts reference to reach the final set point.

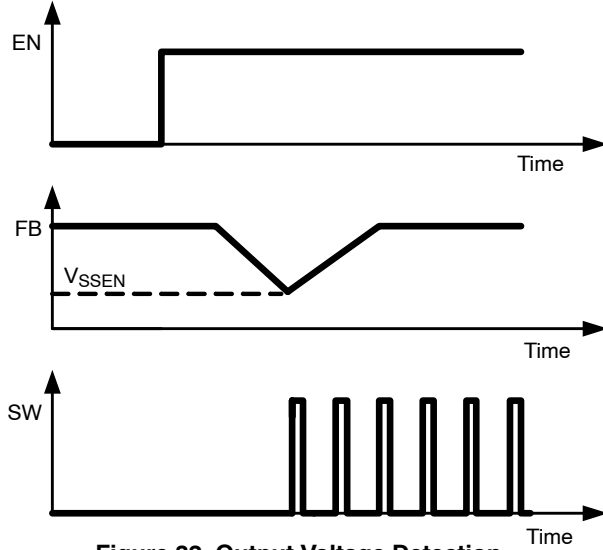


Figure 32. Output Voltage Detection

THERMAL SHUTDOWN

A thermal shutdown circuit inhibits switching, resets the Soft-start circuit, and removes DRV voltage if internal temperature exceeds a safe level. Switching is automatically restored when temperature returns to a safe level.

MINIMUM DROPOUT VOLTAGE

When operating at low input voltages, two parameters play a major role in imposing a minimum voltage drop across the regulator: the minimum off time (that sets the maximum duty cycle), and the on state resistance.

When operating in continuous conduction mode (CCM), the output voltage is equal to the input voltage multiplied by the duty ratio. Because the NCV890231 needs a sufficient bootstrap voltage to operate, its duty cycle cannot be 100%: it needs a minimum off time (t_{OFFmin}) to periodically re-fuel the bootstrap capacitor C_{BST} . This imposes a maximum duty ratio $D_{MAX} = 1 - t_{OFFmin} \cdot F_{SW(min)}$, with the switching frequency being folded back down to $F_{SW(min)} = 500$ kHz to keep regulating at the lowest input voltage possible.

The drop due to the on-state resistance is simply the voltage drop across the Switch resistance R_{DSon} at the given output current: $V_{SWdrop} = I_{OUT} \cdot R_{DSon}$.

Which leads to the maximum output voltage in low V_{in} condition: $V_{OUT} = D_{MAX} \cdot V_{IN(min)} - V_{SWdrop}$

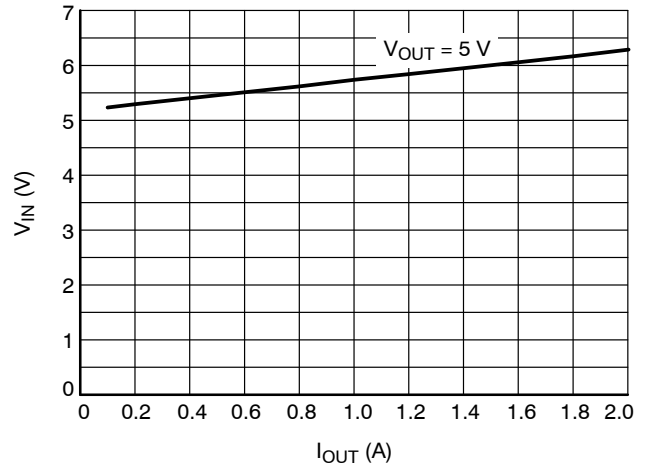


Figure 33. Minimum Input Voltage vs. Output Current

EXPOSED PAD

The exposed pad (EPAD) on the back of the package must be electrically connected to the electrical ground (GND pin) for proper, noise-free operation.

DESIGN METHODOLOGY

The NCV890231 being a fixed-frequency regulator with the switching element integrated, is optimized for one value of inductor. This value is set to $4.7 \mu H$, and the slope compensation is adjusted for this inductor. The only components left to be designed are the input and output capacitor and the freewheeling diode. Please refer to the design spreadsheet www.onsemi.com NCV890231 page that helps with the calculation.

Output capacitor:

The minimum output capacitor value can be calculated based on the specification for output voltage ripple:

$$C_{OUTmin} = \frac{\Delta I_L}{8 \cdot \Delta V_{OUT} \cdot F_{SW}} \quad (\text{eq. 1})$$

With

– ΔI_L the inductor ripple current:

$$\Delta I_L = \frac{V_{OUT} \cdot \left(1 - \frac{V_{OUT}}{V_{IN}}\right)}{L \cdot F_{SW}} \quad (\text{eq. 2})$$

– ΔV_{OUT} the desired voltage ripple.

However, the ESR of the output capacitor also contributes to the output voltage ripple, so to comply with the requirement, the ESR cannot exceed R_{ESRmax} :

$$R_{ESRmax} = \frac{\Delta V_{OUT} \cdot L \cdot F_{SW}}{V_{OUT} \left(1 - \frac{V_{OUT}}{V_{IN}}\right)} \quad (\text{eq. 3})$$

Finally, the output capacitor must be able to sustain the ac current (or RMS ripple current):

$$I_{OUTac} = \frac{\Delta I_L}{2\sqrt{3}} \quad (\text{eq. 4})$$

Typically, with the recommended 4.7 μH inductor, two ceramic capacitors of 10 μF each in parallel give very good results.

Freewheeling diode:

The diode must be chosen according to its maximum current and voltage ratings, and to thermal considerations.

As far as max ratings are concerned, the maximum reverse voltage the diode sees is the maximum input voltage (with some margin in case of ringing on the Switch node), and the maximum forward current the peak current limit of the NCV890231, I_{LIM} .

The power dissipated in the diode is P_{Dloss} :

$$P_{Dloss} = I_{OUT} \cdot \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \cdot V_F + I_{DRMS} \cdot R_D \quad (\text{eq. 5})$$

with:

- I_{OUT} the average (dc) output current
- V_F the forward voltage of the diode
- I_{DRMS} the RMS current in the diode:

$$I_{DRMS} = \sqrt{(1 - D) \left(I_{OUT}^2 + \frac{\Delta I_L^2}{12} \right)} \quad (\text{eq. 6})$$

- R_D the dynamic resistance of the diode (extracted from the V/I curve of the diode in its datasheet).

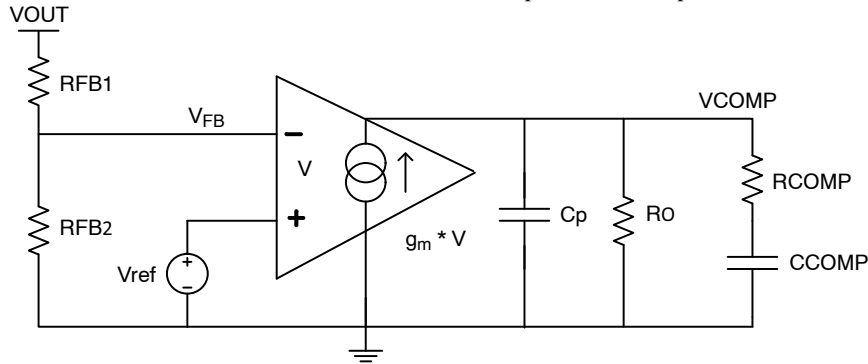


Figure 34. Feedback Compensator Network Model

The transfer function from V_{OUT} to V_{COMP} is the product of the feedback voltage divider and the error amplifier.

$$G_{divider}(s) = \frac{R_{FB2}}{R_{FB1} + R_{FB2}} \quad (\text{eq. 8})$$

$$G_{err_amp}(s) = g_m \cdot R_o \cdot \frac{1 + \frac{s}{\omega_Z}}{\left(1 + \frac{s}{\omega_{pl}}\right) \left(1 + \frac{s}{\omega_{ph}}\right)} \quad (\text{eq. 9})$$

$$\omega_Z = \frac{1}{R_{COMP} \cdot C_{COMP}} \quad (\text{eq. 10})$$

$$\omega_{pl} = \frac{1}{R_o \cdot C_{COMP}} \quad (\text{eq. 11})$$

$$\omega_{ph} = \frac{1}{R_{COMP} \cdot C_p} \quad (\text{eq. 12})$$

The output resistor R_o of the error amplifier is 1.4 $\text{M}\Omega$ and g_m is 1 mA/V . The capacitor C_p is for rejecting noise at high frequency and is integrated inside the IC with a value of 18 pF.

The power stage transfer function (from V_{comp} to output) is shown below:

$$G_{ps}(s) = \frac{R_{load}}{R_i} \cdot \frac{1}{1 + \frac{R_{load} \cdot T_{sw}}{L} \cdot [M_c \cdot (1 - D) - 0.5]} \cdot \frac{1 + \frac{s}{\omega_Z}}{\left(1 + \frac{s}{\omega_p}\right)} \cdot F_h(s) \quad (\text{eq. 13})$$

$$\omega_Z = \frac{1}{R_{esr} \cdot C_{out}} \quad (\text{eq. 14})$$

$$\omega_p = \frac{1}{R_{load} \cdot C_{out}} + \frac{M_c \cdot (1 - D) - 0.5}{L \cdot C_{out} \cdot F_{sw}} \quad (\text{eq. 15})$$

where

$$M_c = 1 + \frac{S_e}{S_n} \quad (\text{eq. 16})$$

$$S_n = \frac{V_{in} - V_{out}}{L} \cdot R_i \quad (\text{eq. 17})$$

R_i represents the equivalent sensing resistor which has a value of $0.183 \, \Omega$, S_e is the compensation slope which is $183 \, \text{kV/S}$, S_n is the slope of the sensing resistor current during on time. $F_h(s)$ represents the sampling effect from the current loop which has two poles at one half of the switching frequency:

$$F_h(s) = \frac{1}{1 + \frac{s}{\omega_n \cdot Q_p} + \frac{s^2}{\omega_n^2}} \quad (\text{eq. 18})$$

$$\omega_n = \pi \cdot F_{sw}$$

$$Q_p = \frac{1}{\pi \cdot [M_c \cdot (1 - D) - 0.5]} \quad (\text{eq. 19})$$

The total loop transfer function is the product of power stage and feedback compensation network.

$$G_{loop}(s) = G_{divider}(s) \cdot G_{err_amp}(s) \cdot G_{ps}(s) \quad (\text{eq. 20})$$

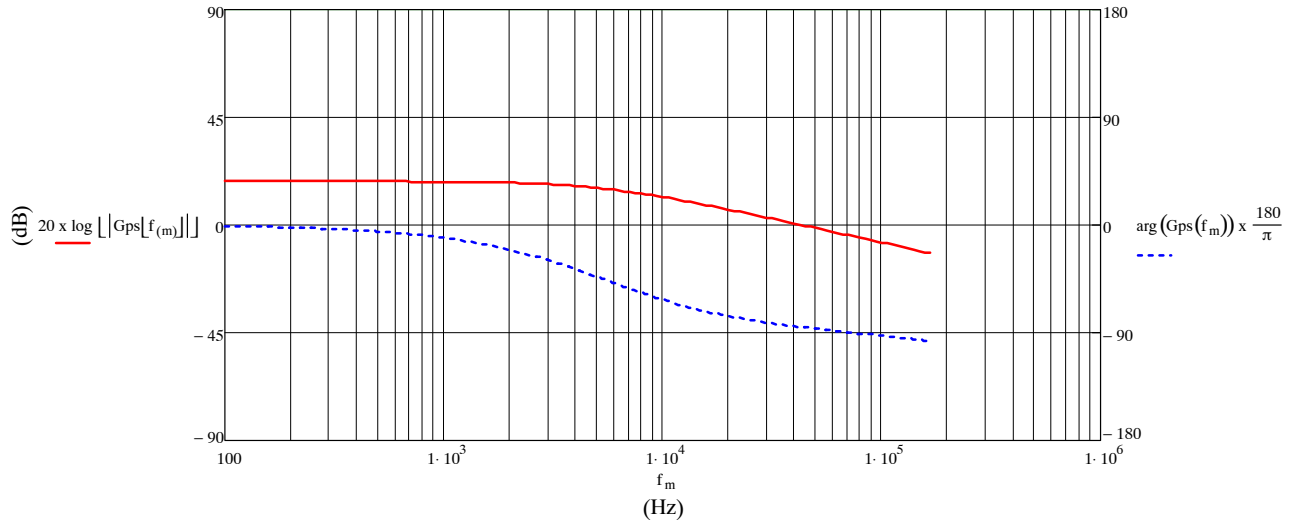


Figure 35. Power Stage Bode Plots

The crossover frequency is chosen to be $F_c = 70 \, \text{kHz}$, the power stage gain at this frequency is $-4 \, \text{dB}$ (0.634) from calculation. Then the gain of the feedback compensation network must be $4 \, \text{dB}$. Next is to decide the locations of one zero and one pole of the compensator. The zero is to provide phase boost at the crossover frequency and the pole is to reject the noise of high frequency. In this example, a zero is placed at $1/10$ of the crossover frequency and a pole is placed at $1/5$ of the switching frequency ($F_{sw} = 2 \, \text{MHz}$):

$$F_z = 7000 \, \text{Hz}, F_p = 400000 \, \text{Hz},$$

R_{COMP} , C_{COMP} and C_p can be calculated from the following equations:

$$R_{COMP} = \frac{F_p \cdot g_m}{(F_p - F_z) \cdot |G_{ps}(F_c)|} \cdot \frac{V_{out}}{V_{ref}} \cdot \frac{\sqrt{1 + \left(\frac{F_c}{F_p}\right)^2}}{\sqrt{1 + \left(\frac{F_z}{F_c}\right)^2}} \quad (\text{eq. 21})$$

$$C_{COMP} = \frac{1}{2\pi \cdot F_z \cdot R_{COMP}} \quad (\text{eq. 22})$$

$$C_p = \frac{1}{2\pi \cdot F_p \cdot R_{COMP}} \quad (\text{eq. 23})$$

Note: there is an $18 \, \text{pF}$ capacitor at the output of the OTA integrated in the IC, and if a larger capacitor needs to be used, subtract this value from the calculated C_p . Figure 36 shows C_p is split into two capacitors. C_{int} is the $18 \, \text{pF}$ in the IC. C_{ext} is the extra capacitor added outside the IC.

From the calculation:

$R_{COMP} = 6.6 \text{ K}\Omega$, $C_{COMP} = 3.4 \text{ nF}$, $C_p = 48 \text{ pF}$

So the feedback compensation network is as below:

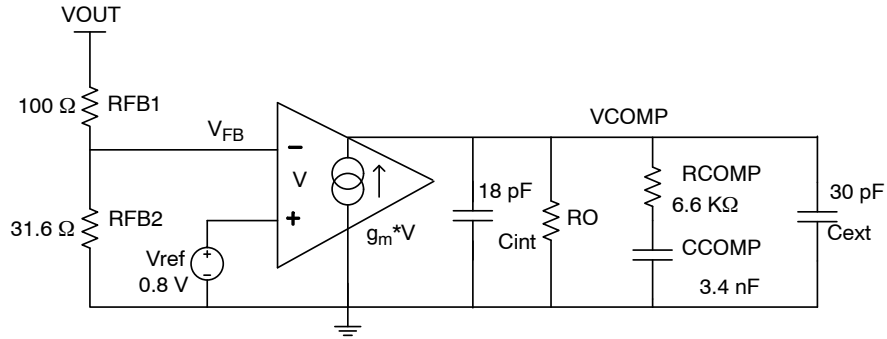


Figure 36. Example of the Feedback Compensation Network

Figure 37 shows the bode plot of the OTA compensator

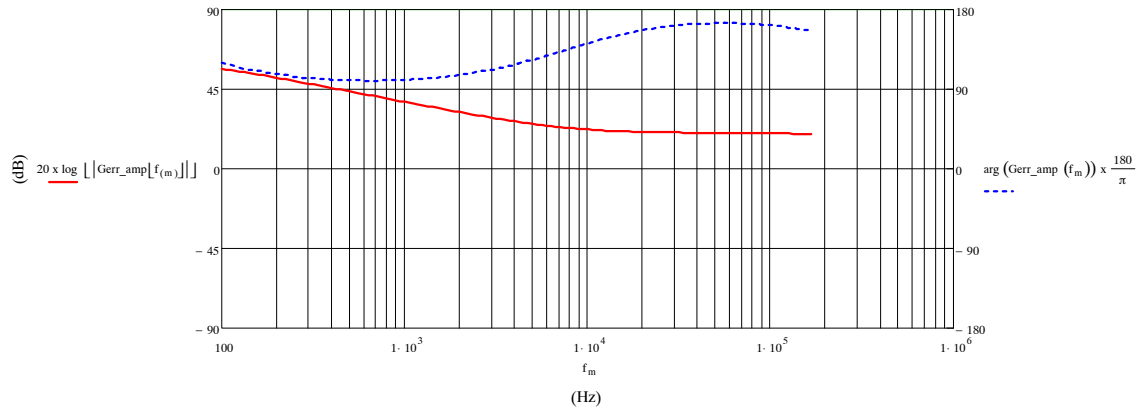


Figure 37. Bode Plot of the OTA Compensator

The total loop bode plot is as below:

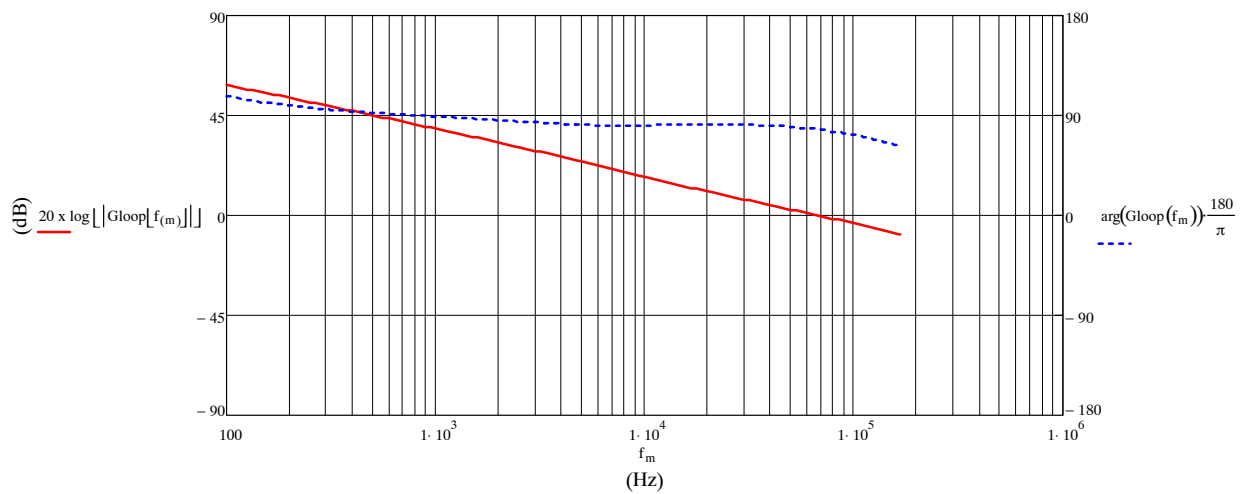


Figure 38. Bode Plot of the Total Loop

The crossover frequency is at 70 KHz and phase margin is 75 degrees.

NCV890231

PCB LAYOUT RECOMMENDATION

As with any switching power supplies, there are some guidelines to follow to optimize the layout of the printed circuit board for the NCV890231. However, because of the high switching frequency extra care has to be taken.

- Minimize the area of the power current loops:
 - ♦ Input capacitor → NCV890231 switch → Inductor
→ output capacitor → return through Ground
- Minimize the length of high impedance signals, and route them far away from the power loops:
 - ♦ Freewheeling diode → inductor → Output capacitor
→ return through ground
 - ♦ Feedback trace
 - ♦ Comp trace

ORDERING INFORMATION

Device	Package	Shipping [†]
NCV890231MWTXG	DFN10 with wettable flanks (Pb-Free)	3000 / Tape & Reel

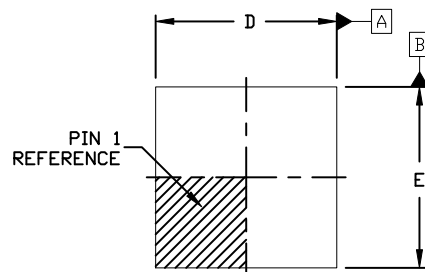
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



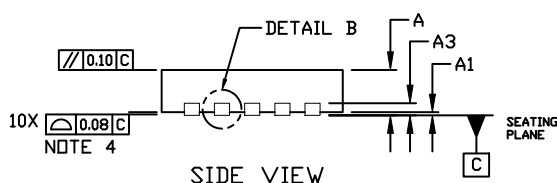
SCALE 2:1

DFN10, 3x3, 0.5P
CASE 485C
ISSUE F

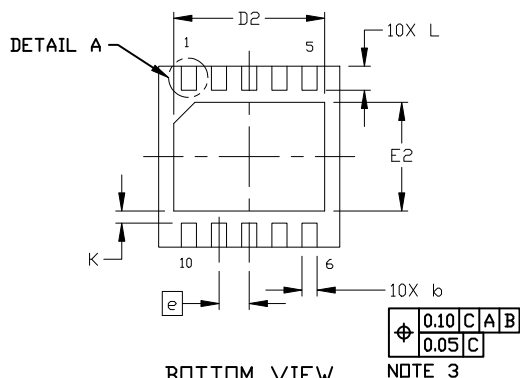
DATE 16 DEC 2021



TOP VIEW

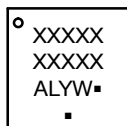


SIDE VIEW



BOTTOM VIEW

GENERIC
MARKING DIAGRAM*



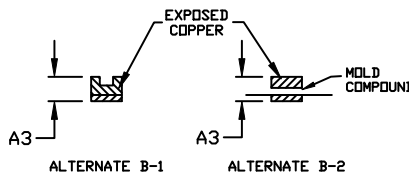
XXXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

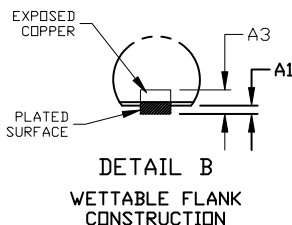
NOTES:

1. DIMENSION AND TOLERANCING PER ASME Y14.5, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. TERMINAL b MAY HAVE MOLD COMPOUND MATERIAL ALONG SIDE EDGE. MOLD FLASH MAY NOT EXCEED 30 MICRONS ONTO BOTTOM SURFACE OF TERMINAL.
6. FOR DEVICE OPN CONTAINING W OPTION, DETAIL A AND DETAIL B ALTERNATE CONSTRUCTIONS ARE NOT APPLICABLE. WETTABLE FLANK CONSTRUCTION IS DETAIL B AS SHOWN ON SIDE VIEW OF PACKAGE.

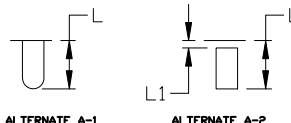


DETAIL B

ALTERNATE CONSTRUCTION



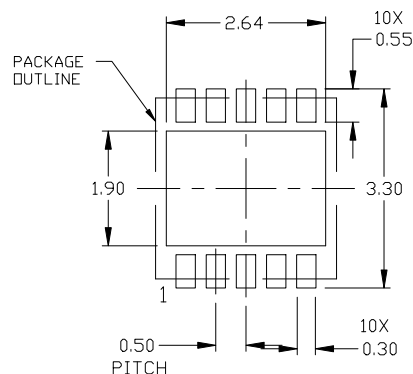
DETAIL B
WETTABLE FLANK
CONSTRUCTION



DETAIL A

ALTERNATE CONSTRUCTION

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.80	0.90	1.00
A1	0.00	---	0.05
A3	0.20 REF		
b	0.18	0.23	0.30
D	2.90	3.00	3.10
D2	2.40	2.50	2.60
E	2.90	3.00	3.10
E2	1.70	1.80	1.90
e	0.50 BSC		
K	0.20 REF		
L	0.30	0.40	0.50
L1	---	---	0.03



RECOMMENDED
MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON03161D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	DFN10, 3X3 MM, 0.5 MM PITCH	PAGE 1 OF 1

onsemi and Onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation
onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at
www.onsemi.com/support/sales